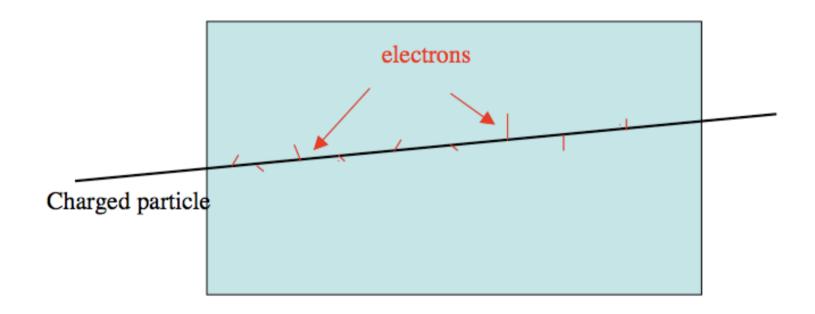
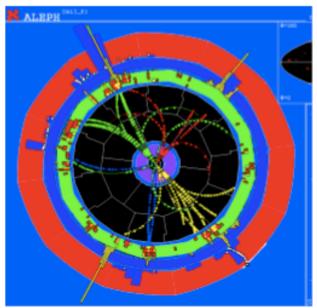
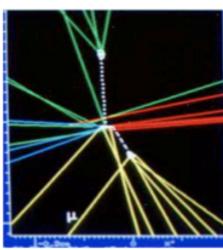


### **Interactions with Matter**

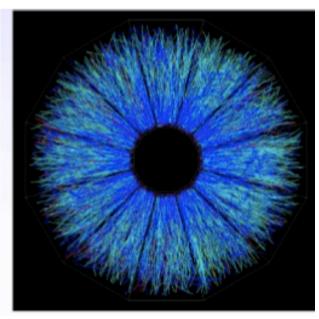


# e+ e- collision in the ALEPH Experiment/LEP.



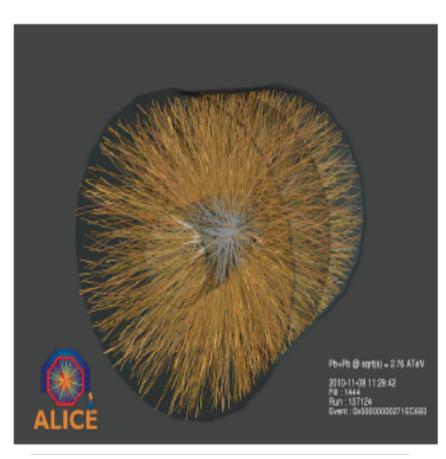


# Au+ Au+ collision in the STAR Experiment/RHIC Up to 2000 tracks



#### Pb+ Pb+ Kollision in the ALICE Experiment/LHC

Up to 40 000 tracks/collision



### Multiple Scattering

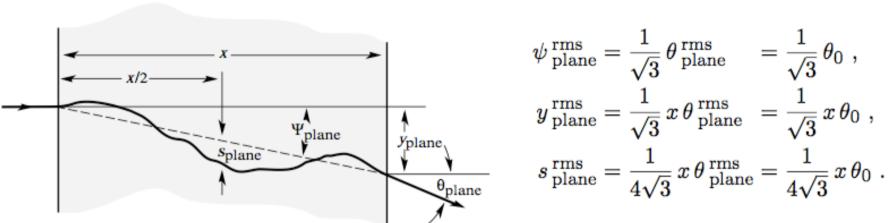


Figure 27.9: Quantities used to describe multiple Coulomb scattering. The particle is incident in the plane of the figure.

A particle which traverses a medium is deflected by small angle Coulomb scattering from nuclei. For hadronic particles also the strong interaction contributes.

The angular deflection after traversing a distance x is described by the Molière theory. The angle has roughly a Gauss distribution, but with larger tails due to Coulomb scattering.

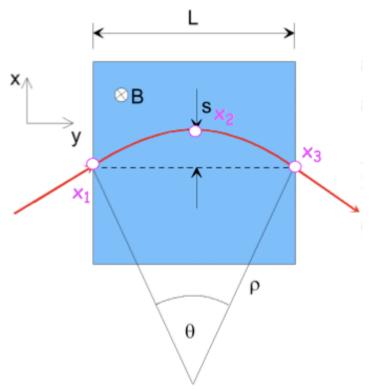
Defining: 
$$\theta_0 = \theta_{\mathrm{plane}}^{\mathrm{rms}} = \frac{1}{\sqrt{2}} \theta_{\mathrm{space}}^{\mathrm{rms}}$$

Gaussian approximation:

$$\theta_0 = \frac{13.6 \text{ MeV}}{\beta cp} z \sqrt{x/X_0} \Big[ 1 + 0.038 \ln(x/X_0) \Big]$$

#### Momentum Measurements in B-field

The momentum is measured from the sagitta s, which gives the curvature  $\rho$  of the track in the magnetic field.

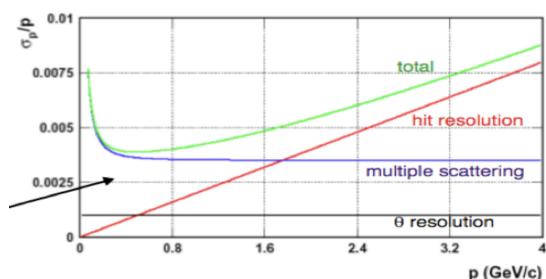


Transverse momentum:

$$p_T = qB\rho$$
  
 $p_T[GeV] = 0.3 \ B[T] \ \rho[m]$ 

$$\frac{L/2}{\rho} = \sin \frac{\theta}{2} \approx \frac{\theta}{2} \text{ (for small } \theta) \Rightarrow \theta \approx \frac{L}{\rho} = \frac{0.3BL}{p_T}$$

$$s = \rho(1 - \cos\frac{\theta}{2}) \approx \rho\left(1 - \left(1 - \frac{1}{2}\frac{\theta^2}{4}\right)\right) = \rho\frac{\theta^2}{8} \approx \frac{0.3BL^2}{8p_T}$$



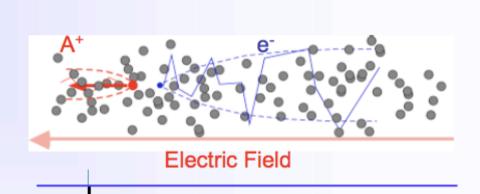
#### Drift and Diffusion in Gases

E=0 thermal diffusion

$$\langle v \rangle_{\iota} = 0$$

E>0 charge transport and diffusion

$$\langle \boldsymbol{v} \rangle_{\scriptscriptstyle L} = \boldsymbol{v}_{\scriptscriptstyle D}$$



from L.Ropelewski

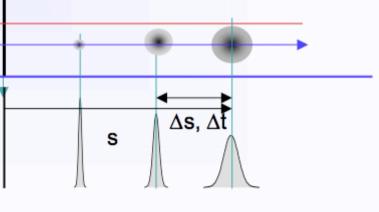
$$v_{D} = \frac{\Delta s}{\Delta t}$$

$$\sigma_{x} = \sqrt{2Dt} = \sqrt{2D\frac{s}{v_{D}}}$$

Electron swarm drift

Drift velocity

Diffusion



# Lorentz Angle in a magnetic Field

Lorentz angle (deflection angle of drift electrons due to magnetic field)

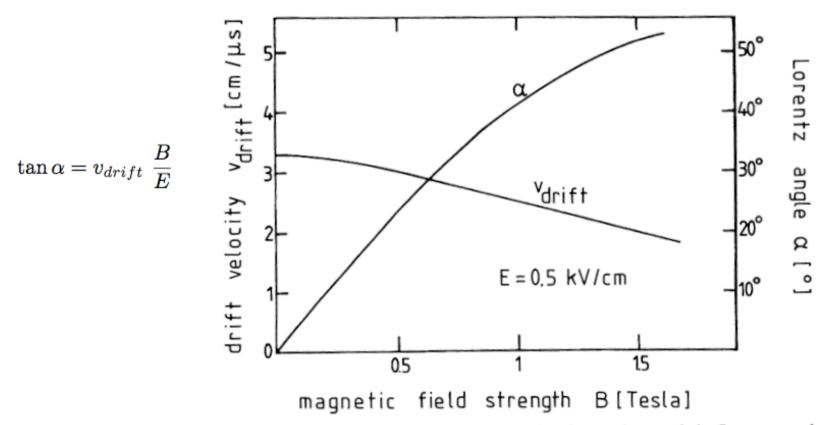
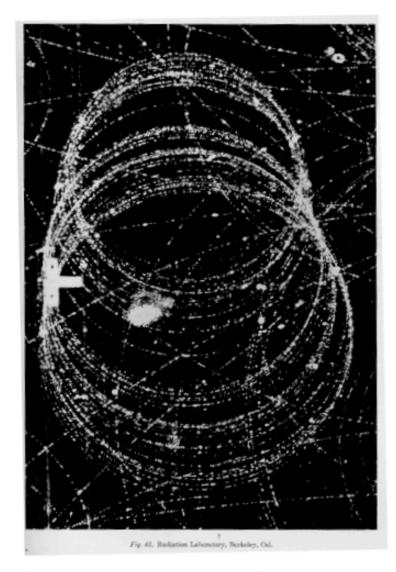
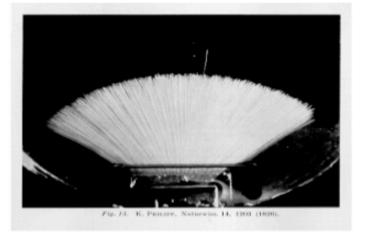


Fig. 1.21. Dependence of the electron drift velocity  $\vec{v}_{\text{drift}}$  and the Lorentz angle  $\alpha$  on the magnetic field for low electric field strengths (500 V/cm) in a gas mixture of argon (67.2%), isobutane (30.3%) and methylal (2.5%) [51, 95].

### History of Tracking: Cloud Chambers



Fast electron in a magnetic field at the Bevatron, 1940



α-particles in air.

In cloud chambers a charged particle causes condensation of a supersaturated gas.

The picture (left) shows and electron with 16.9 MeV initial energy.

It spirals about 36 times in the magnetic field.

Nobel prizes related to cloud chamber development:

C. T. R. Wilson, 1927

P.M.S. Blackett, 1948 (triggered chambers)

### History of Tracking: Cloud Chambers

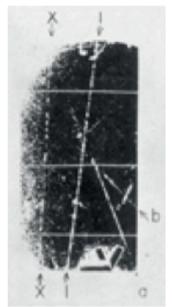
#### **CERN Courier**

Sep 27, 2012

#### From the October 1969 issue

#### Quark candidates in Sydney

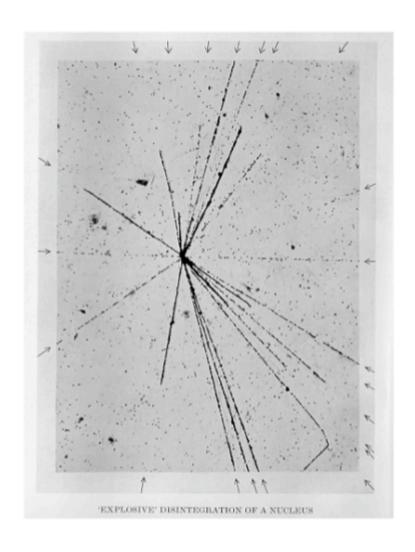
A report, by a team from the Cornell-Sydney University Astronomy Centre, Australia, on a high-energy cosmic-ray search which seems to have evidence for quarks, appeared in *Physical Review Letters* on 22 September. A preliminary announcement was made at the 11th International Conference on Cosmic Ray Physics in Budapest, 25 August to 4 September, and on 8 September L S Peak, who participated

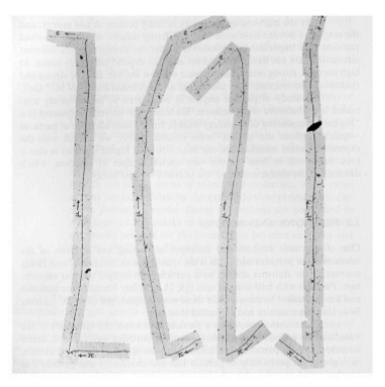


Wilson cloud chamber

in the experiment with L Cairns, R L S Woolcott and team leader C B A McCusker, spoke at CERN about their intriguing findings.

# History of Tracking: Emulsion





Discovery of muon and pion

Emulsion detectors are still used today: Opera experiment at Gran Sasso for the identification of tau decays.

### History of Tracking: Bubble Chambers

Cloud chamber: supersaturating a gas with a vapor.

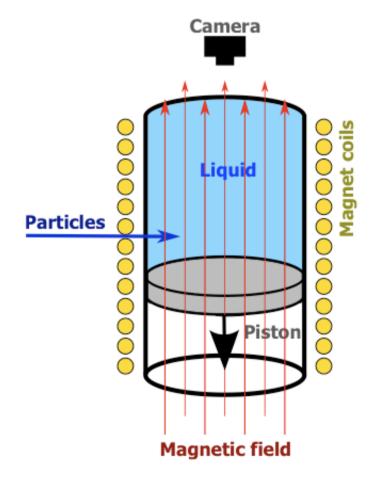
Bubble chamber: superheated liquid. Invented by Donald A. Glazer, Nobel Prize 1960.

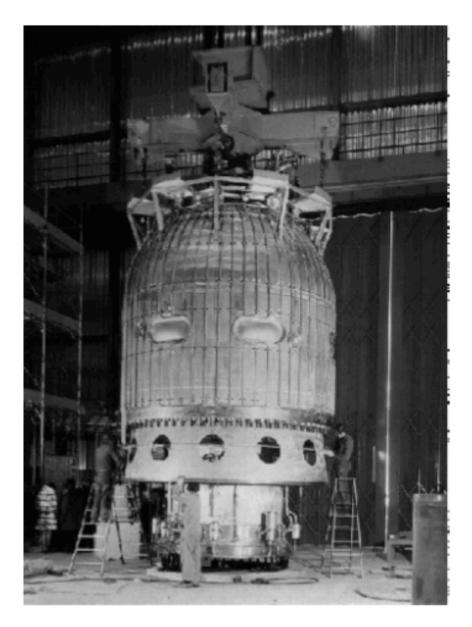
A particle depositing energy along it's path makes the liquid boil and forms bubbles.



The 80-inch Bubble Chamber

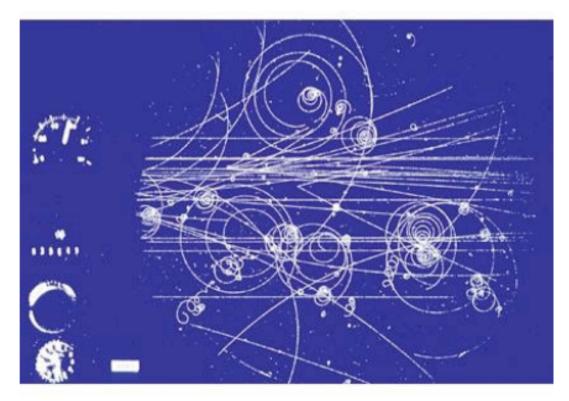
BNL, First Pictures 1963, 0.03s cycle





3.7 meter hydrogen bubble chamber at CERN, equipped with the largest superconducting magnet in the world at that time.

During its working life from 1973 to 1984, the "Big European Bubble Chamber" (BEBC) took over 6 million photographs.



Can be seen outside the Microcosm Exhibition

#### **Bubble Chambers**

The excellent position (5µm) resolution and the fact that target and detecting volume are the same (H chambers) makes the Bubble chamber almost unbeatable for reconstruction of complex decay modes.

The drawback of the bubble chamber is the low rate capability (a few tens/ second). E.g. LHC 10<sup>9</sup> collisions/s.

The fact that it cannot be triggered selectively means that every interaction must be photographed.

Analyzing the millions of images by 'operators' was a quite laborious task.

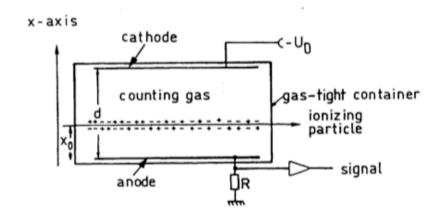
That's why electronics detectors took over in the 70ties.

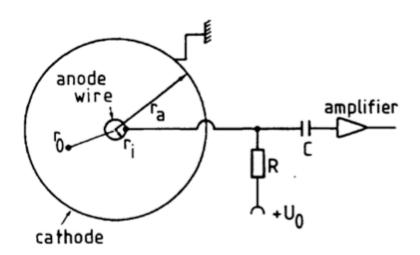
#### **Ionization Chambers**

- simplest Gas Detector
- Basically a Capacitor
- Also possible with liquids and solids

 Ionization (electrons and ions) drift to anode and cathode

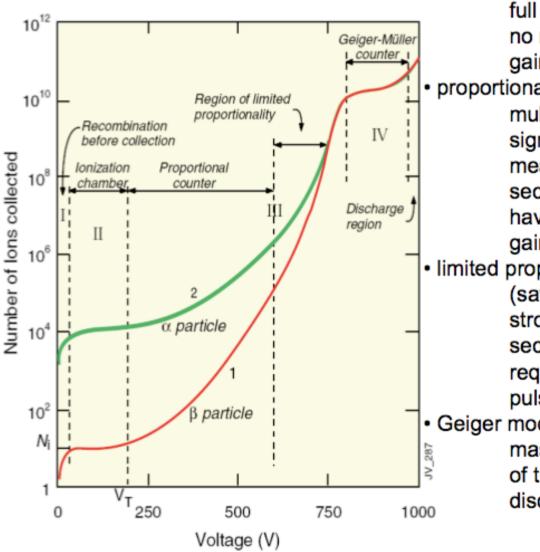
If time constant of RC is large enough: Integrated signal  $\propto$  Ionization loss





#### Ionization Chambers

#### SWPC OPERATION MODE



ionization mode

full charge collection no multiplication gain ~ 1

proportional mode

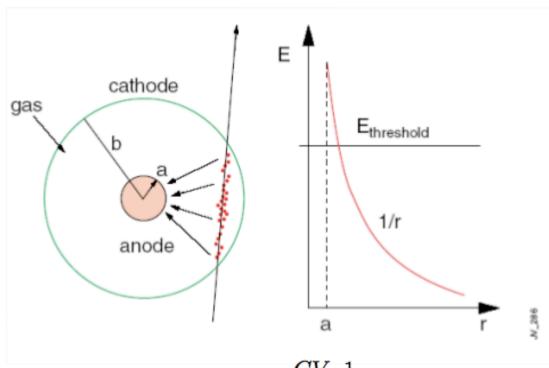
multiplication of ionization signal proportional to ionization measurement of dE/dx secondary avalanches have to be quenched; gain  $\sim 10^4 - 10^5$ 

 limited proportional mode (saturated, streamer) strong photoemission secondary avalanches requires strong quenchers or pulsed HV; gain ~ 1010

Geiger mode

massive photoemission; full length of the anode wire affected; discharge stopped byHV cut

### Proportional Chamber: Single Wire



Electric field: 
$$E(r) = \frac{CV_0}{2\pi\epsilon_0} \frac{1}{r}$$

Potential: 
$$V(r) = \frac{CV_0}{2\pi\epsilon_0} \ln \frac{r}{a}$$

 $V_0$  = voltage between anode-cathode

Capacitance per length 
$$C = \frac{2\pi\epsilon}{\ln(b/a)}$$

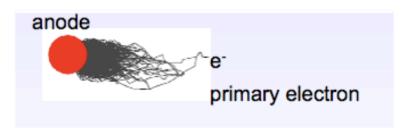
Electrons produced by ionization drift to the anode wire.

#### Avalanche:

- Close to the wire (Ø about few tens of μm) the E-field is very large (> 10 kV/cm).
- Between collisions electrons gain enough energy to ionize gas.
- Exponential increase of number of electron/ion pairs (gas amplification)

$$n = n_0 e^{\alpha(E)x}$$

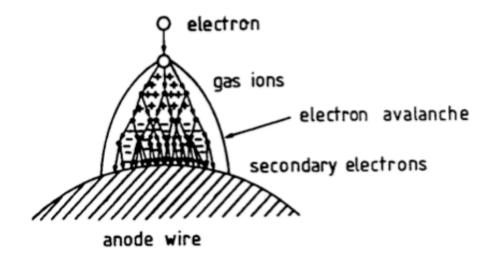
a is the first Townsend coefficient.



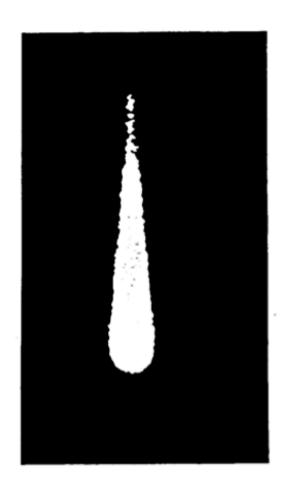
### Proportional Chambers

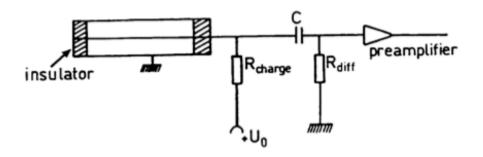
- Like Ionization chamber, but smaller wire and/or higher voltage
- Charge multiplication close to wire  $(E \propto 1/r)$
- Electrons gain enough energy between collisions to ionize themselves.

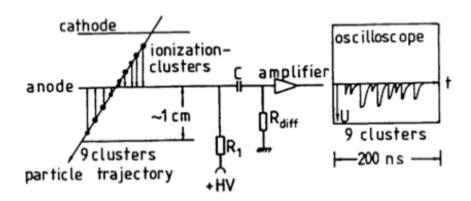
- Proportional: Gas amplification constant
  - $\rightarrow$  Signal  $\propto$  primary ionization



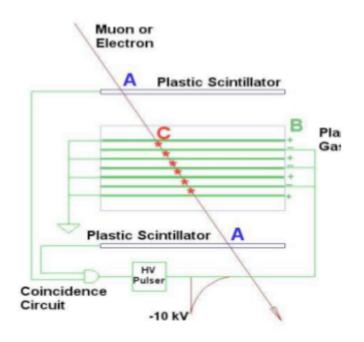
# Proportional Chambers







### Spark Chamber



A charged particle traverses the detector and leaves an ionization trail.

The scintillators trigger an HV pulse between the metal plates and sparks form in the place where the ionization took place.

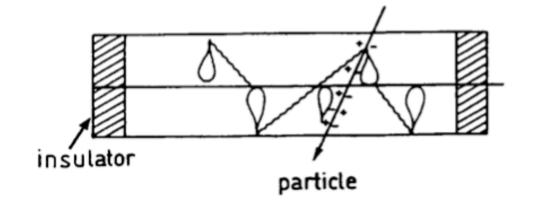
The Spark Chamber was developed in the early 60ies.

Schwartz, Steinberger and Lederman used it in discovery of the muon neutrino

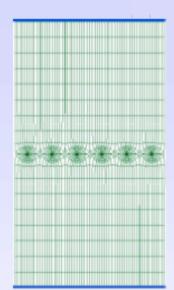


### Geiger-Muller Counter

- Even higher voltage
- Copious production of photons in avalanche
- Photons make more ionization by photoelectric effect
- Also far away from original avalanche
- To stop discharge:
  - Make charge resistor big enough so voltage drops enough (quenching by resistor)
  - Add alcohols (methylal, ethylaclohol) or hydrocarbons (methan, ethane, isobutane) to counting gas (usually argon):
    - Absorb UV photons, reduce free path



### Multi-Wire proportional Chamber



Simple idea to multiply SWPC cell: Nobel Prize 1992

from L. Ropelewski



First electronic device allowing high statistics experiments !!

Typical geometry 5mm, 1mm, 20 μm

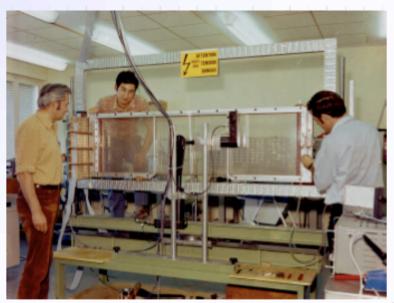
Normally digital readout : spatial resolution limited to

$$\sigma_x \approx \frac{d}{\sqrt{12}}$$

for d=1 mm 
$$\sigma_x = 300 \mu m$$

$$\langle x^2 \rangle = \frac{\int_0^{d/2} x^2 dx}{\int_0^{d/2} dx} = \frac{2}{d} \frac{x^3}{3} \Big|_0^{d/2} = \frac{d^2}{12}$$

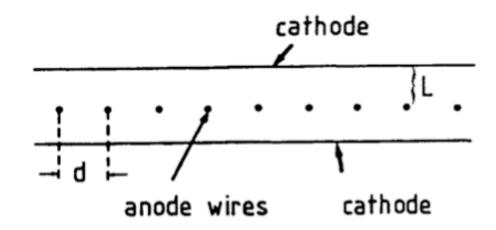
#### First large size MWPC

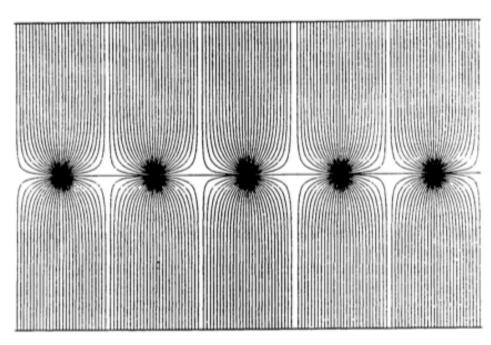


G. Charpak, F. Sauli and J.C. Santiard ,1970

### Multi-Wire Propotional Chambers

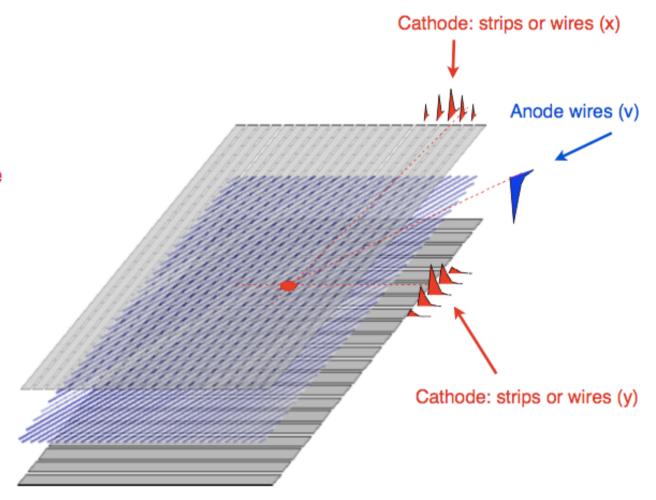
- George Charpak, beginning of 1960's, Nobel Price 1992
- Typical wire distance d: a few mm (> 0.8 mm)
- Typical wire diameter:  $10 \,\mu\text{m} 30 \,\mu\text{m}$
- Sizes: up to square meters. Limited by wire tension and electrostatic repulsion.
- Electronic: Discriminator (threshold).
- Resolution:  $\sigma(x) = d/\sqrt{12}$
- space information only in one dimension
- Rotate second identical module for other dimension
- Segmented cathode readout for other dimension



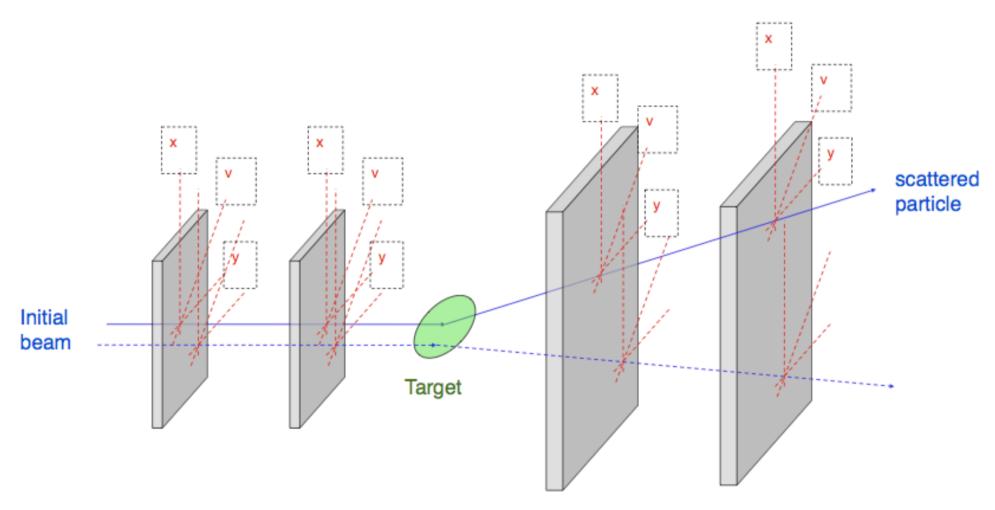


# Multi-wire Proportional Chambe

Two coordinates (x,y) of the track hit can be determined from the position of the anode wire and the signal induced on the cathode strips (or wires).

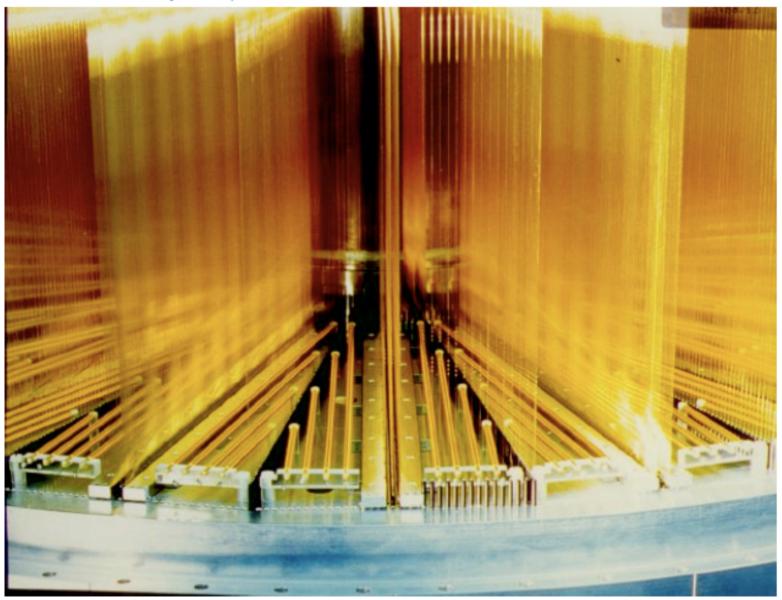


# MWPC: Experimental set-up



With this experimental set-up based on MWPC an event rate of about 100 000 Hz can be processed. The position resolution in each layer is about 1 mm.

MWPC with many wire planes.

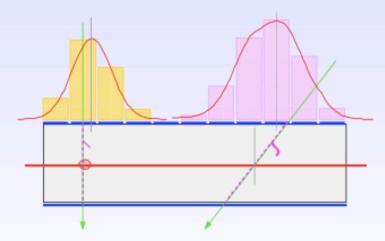




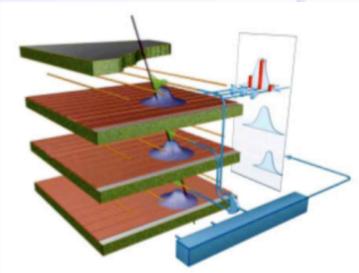
# Cathode Strip Chambers

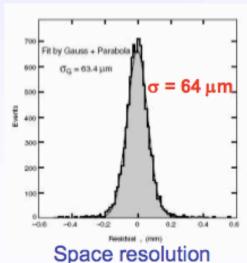
from L. Ropelewski

Precise measurement of the second coordinate by interpolation of the signal induced on pads. Closely spaced wires makes CSC fast detector.



Center of gravity of induced signal method.

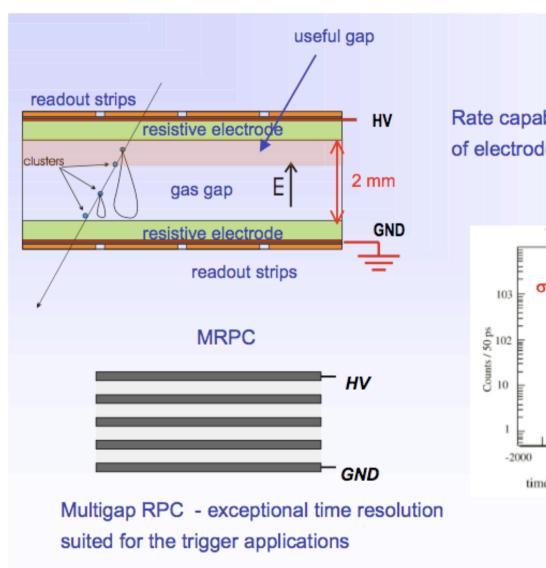






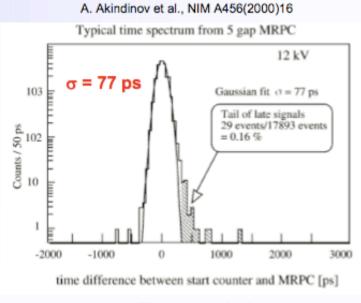
**CMS** 

#### Resistive Plate Chambers



from L. Ropelewski

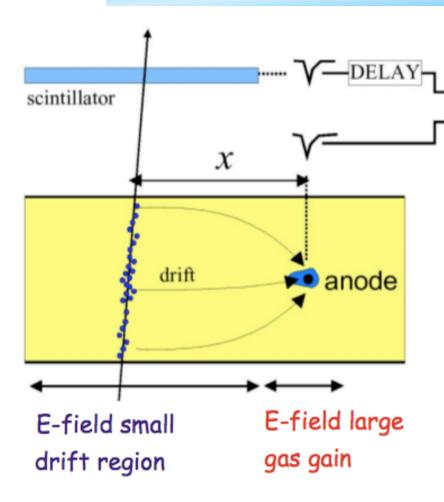
Rate capability strong function of the resistivity of electrodes in streamer mode.



Time resolution

#### Driftchamber

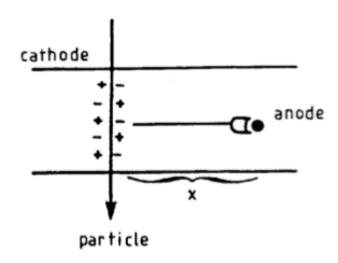
Stop



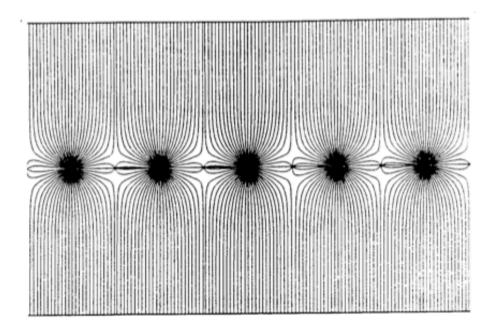
TDC: Time to Digital Converter

- Get external time reference t<sub>0</sub> (scintillator)
- Measure arrival time of electrons at anode t<sub>1</sub>
- x- coordinate given by  $x = \int_{t_0}^{t_1} v_D(t) \; dt$
- advantage of drift chamber: much larger sensitive volume per readout channel.

#### Planar Drift Chambers



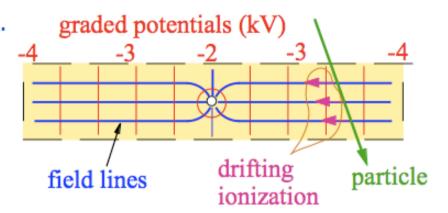
- Heintze, Walenta, ≈ 1968, also others.
- Make wires further apart
- use drift time to wire as additional information
- additional potential wire
- drift distances several cm
- resolution: limited by diffusion. small chambers:  $\sigma > 20 \,\mu\text{m}$ larger chambers a few  $100 \,\mu\text{m}$



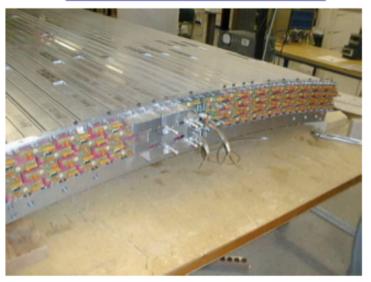
#### Driftchamber

- Use graded potential to get uniform drift field.
- Gas amplification near anode wire.
- Position resolution ( $\sigma$ = 50 200  $\mu$ m)
  - v(t) distortions near wire
  - ionisation fluctuations
  - diffusion
  - electronic noise

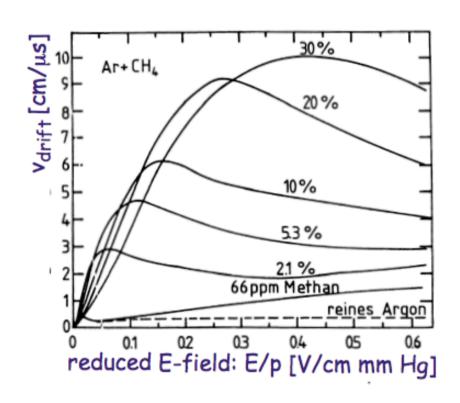
#### drift cell

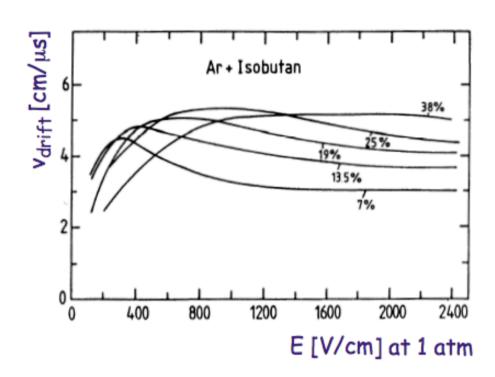


#### CDF muon chambers



# Driftchamber: Drift Velocity



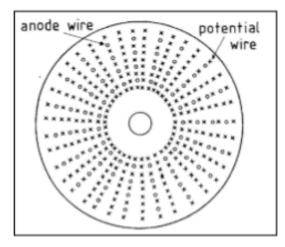


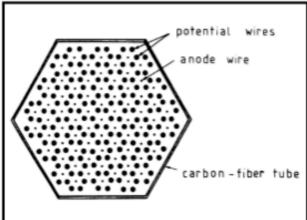
Some gas mixtures have a strong variation of drift velocity as function of E-field.

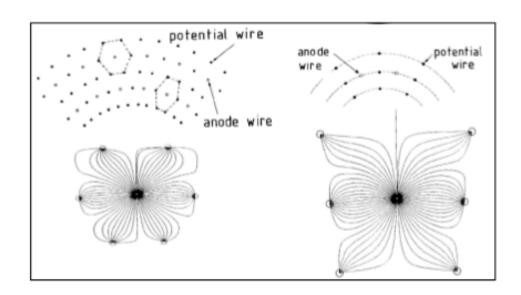
For stable operation it is useful to operate at maximum / plateau.

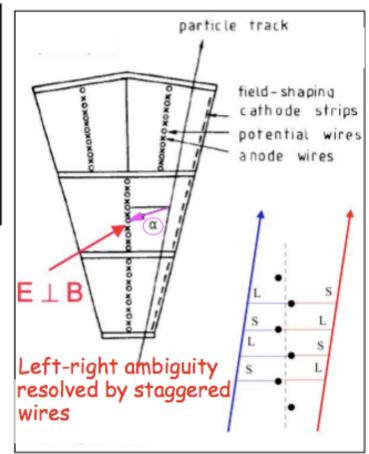
Typical drift velocities: 2-10 cm/µs

# Cylindrical Drift Chamber







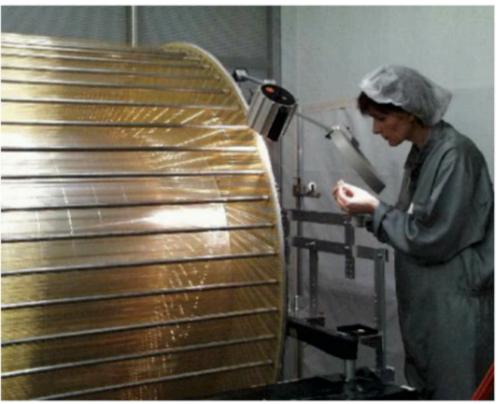


cell of a "jet"-driftchamber

# Cylindrical Drift Chamber







- ≈ 15000 wires
- total force from wire tension ≈ 6 tons

# The ATLAS Muon Spectrometer

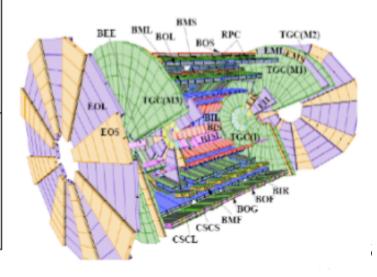
Monitored drift tubes	MDT
- Coverage	$ \eta  < 2.7$ (innermost layer: $ \eta  < 2.0$ )
- Number of chambers	1088 (1150)
- Number of channels	339 000 (354 000)
- Function	Precision tracking
Cathode strip chambers	CSC
- Coverage	$2.0 <  \eta  < 2.7$
- Number of chambers	32
- Number of channels	31 000
- Function	Precision tracking
Resistive plate chambers	RPC
- Coverage	$ \eta  < 1.05$
- Number of chambers	544
- Number of channels	359 000
- Function	Triggering, second coordinate
Thin gap chambers	TGC
- Coverage	$1.05 <  \eta  < 2.7$ (2.4 for triggering)
- Number of chambers	3588
- Number of channels	318 000
- Function	Triggering, second coordinate

#### A complex system:

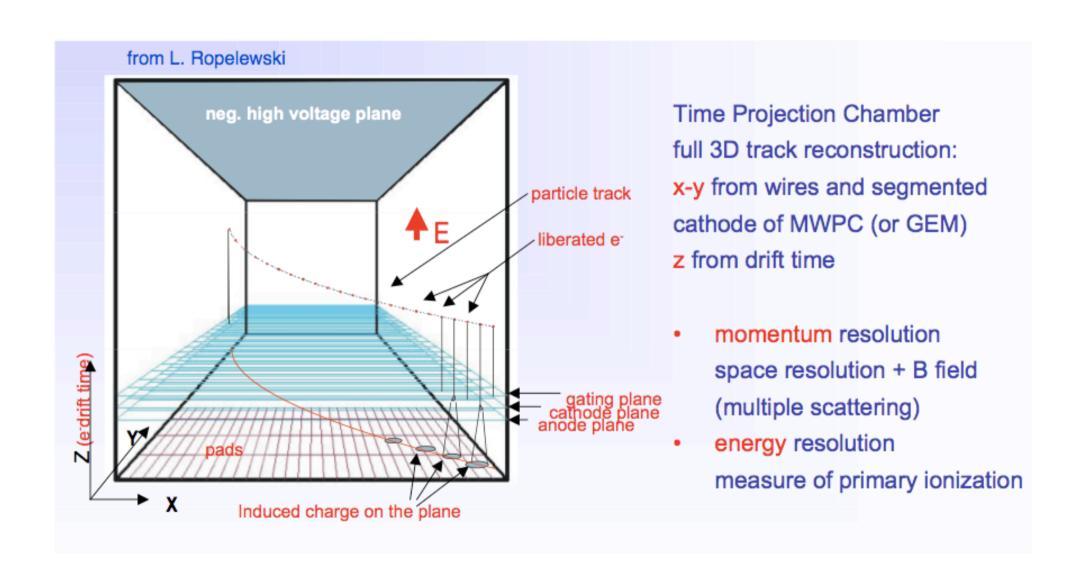
4 different technologies (MDT,CSC,RPC,TGC)

Large area (10,000 m<sup>2</sup>)

Many channels (IM)



# Time Projection Chamber (TPC)



## TPC Time Projection Chamber

Developed by D. Nygren in the 70's.

Large gas volume with central electrode.

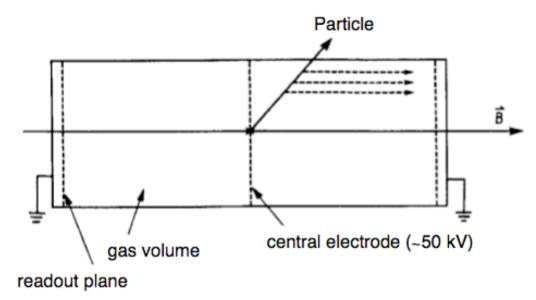
Drift distance of several meters.

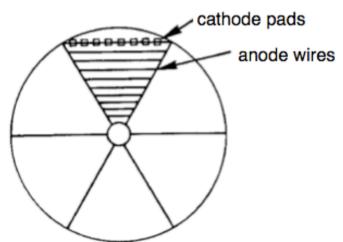
Signal registered with MWPC, anode wires and cathode pads provide x,y; drift time gives z.

Transverse diffusion reduced (electrons spiral around E-field, since E II B, Lamor radius < 1  $\mu$ m)

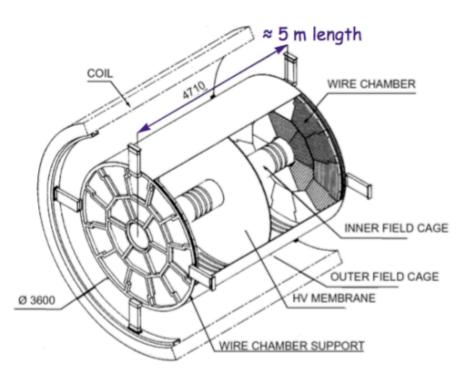
Very good 3D hit resolution and dE/dx.

Long drift times ( $\approx$  40  $\mu$ s), thus rate limitations and very good gas quality required.





### ALEPH TPC at LEP

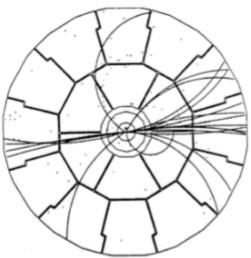


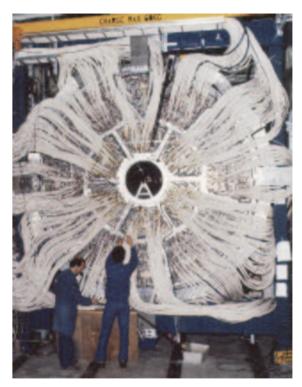
#### achieved resolutions:

 $\sigma_{r\phi}$  = 170  $\mu m$ 

 $\sigma_z$  = 740  $\mu$ m

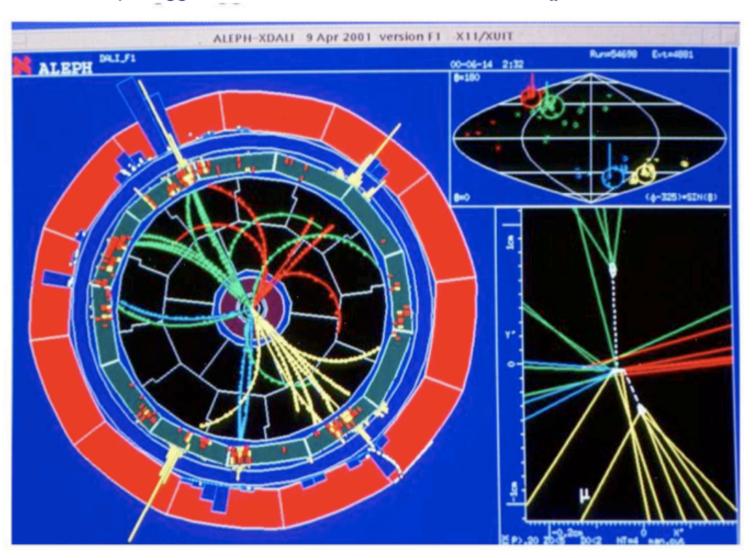
#### $r \! - \! \varphi$ projection





### ALEPH TPC at LEP

Aleph Higgs Candidate Event: e<sup>+</sup> e<sup>-</sup> → HZ → bb + jj

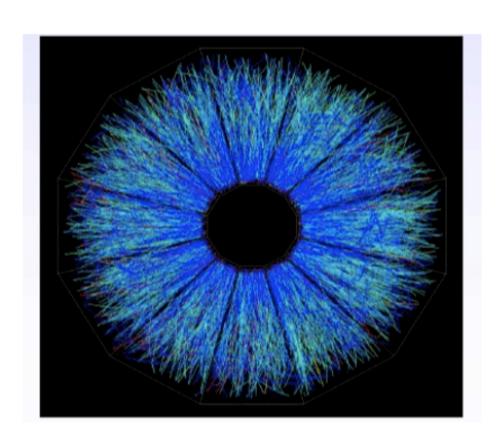


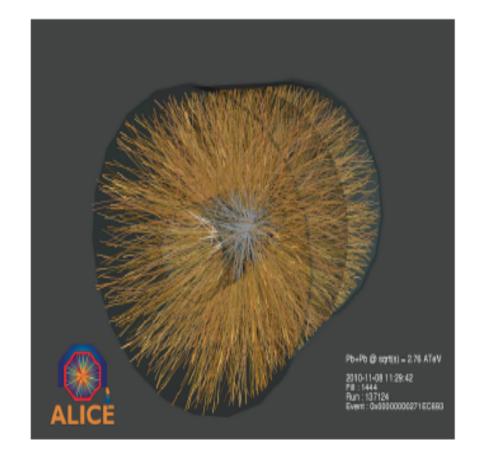
# TPC for Heavy Ion Collisions

Au+ Au+ collision in the STAR Experiment/RHIC Up to 2000 tracks

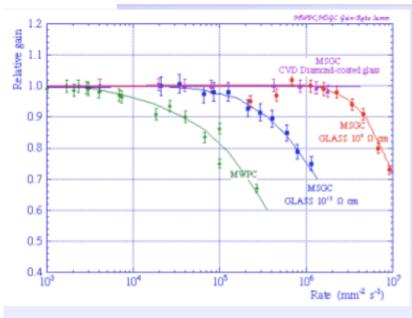
Pb+ Pb+ Kollision in the ALICE Experiment/LHC

Angle Θ=60 to 62°
Up to 40 000 tracks/collision





### Micropattern Gas Chambers



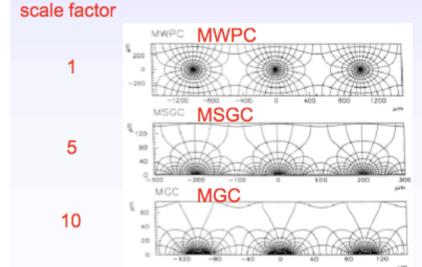
Advantages of gas detectors:

from L. Ropelewski

- low radiation length
- large areas at low price
- flexible geometry
- spatial, energy resolution ...

#### Problem:

 rate capability limited by space charge defined by the time of evacuation of positive ions

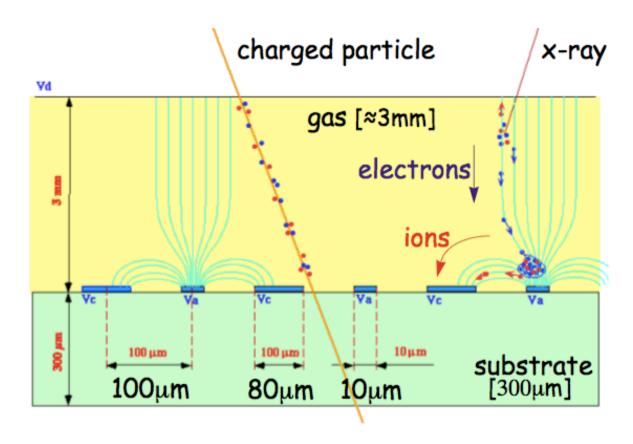


R. Bellazzini et al.

#### Solution:

 reduction of the size of the detecting cell (limitation of the length of the ion path) using chemical etching techniques developed for microelectronics and keeping at same time similar field shape.

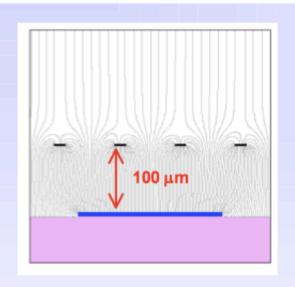
### Microstrip Gas Chamber

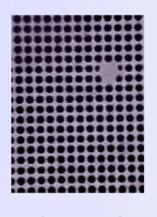


#### Advantages:

- Very precise and small anode/cathode structures can be produced with lithographical methods. Thus very good position resolution is possible.
- MSGC provide high mechanical stability
- small drift distance for ions, thus high rate capability.

### Micromegas: Micromesh Gaseous Structure



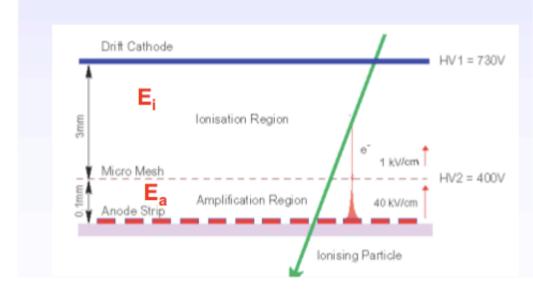


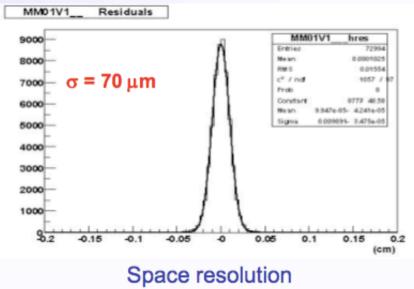
micromesh

Micromesh mounted above readout structure (typically strips).

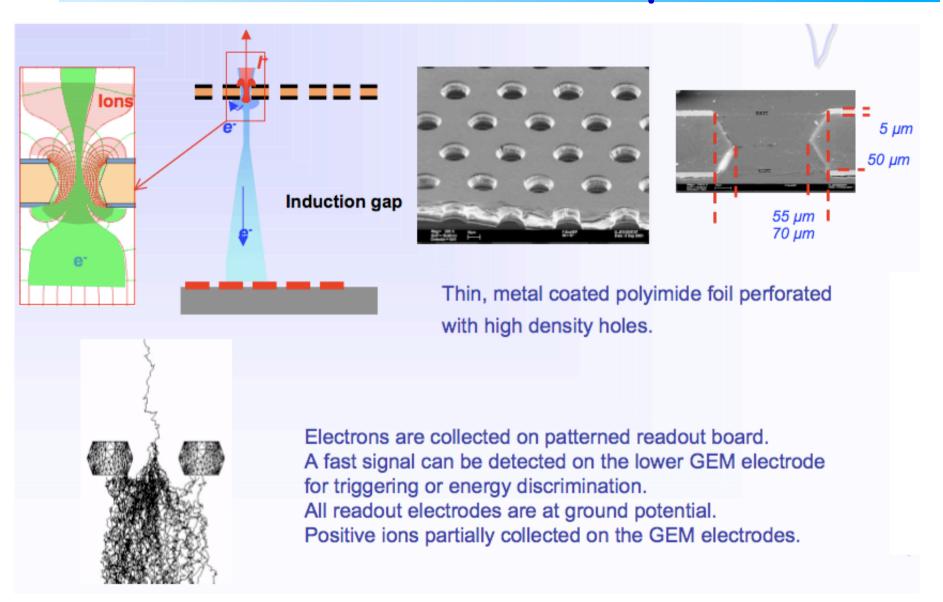
E field similar to parallel plate detector.

 $E_a/E_i \sim 50$  to secure electron transparency and positive ion flowback supression.

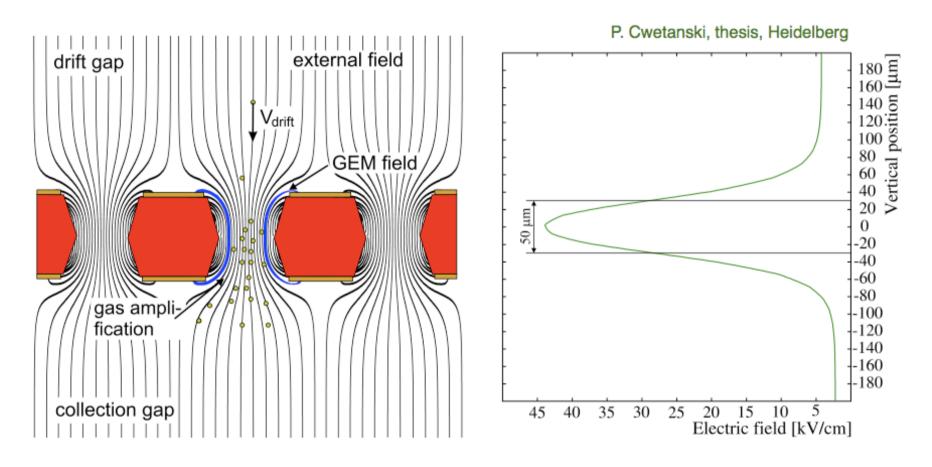




# Gas Electron Multiplier



### GEM: Gas Electron Multiplier

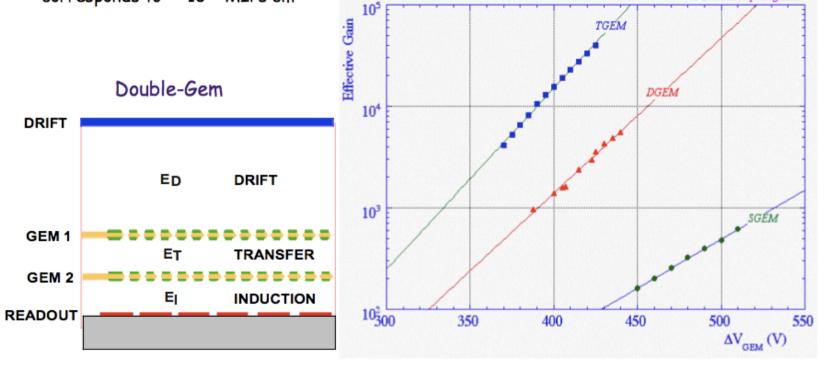


For a voltage between the GEM foils of 360 V the E-Field inside the gap reaches very high values, which cause gas amplification.

### GEM Characteristics

- Rate capability ~ 1 MHz mm<sup>-2</sup>
- Position accuracy (MIPs)  $\sigma$  ~ 60  $\mu m$
- Radiation tolerance > 100 mC mm<sup>-2</sup>

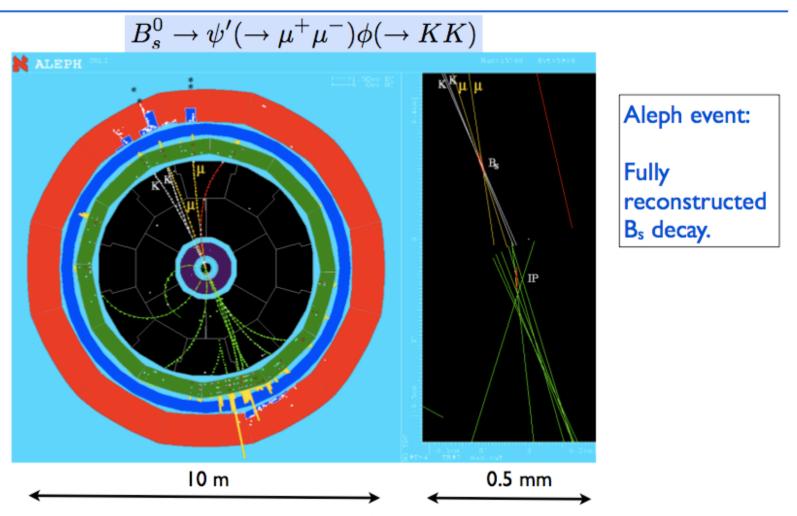
- corresponds to  $\sim 10^{14} \, \mathrm{MIPs \ cm^{-2}}$ 



S-D-T GEM equvolt-gain bis

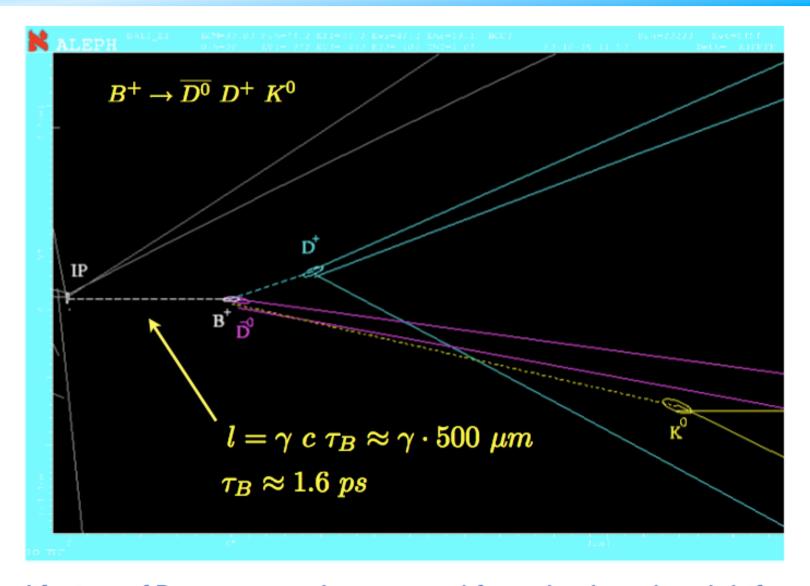
# Semiconductor Detectors

### Need for semi-conductor tracker



Track measurements with a precision of a few µm near the interaction point improve the momentum measurement and allow to determine the decay vertex, especially important for bottom hadrons.

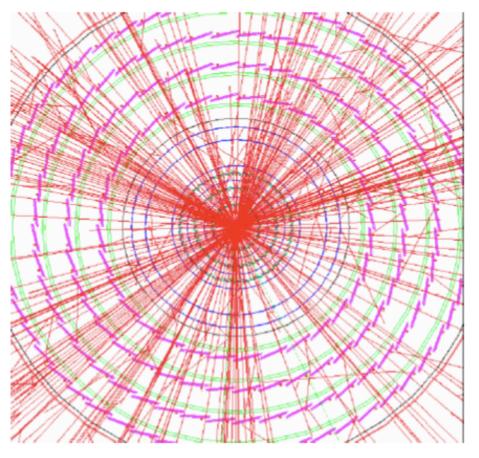
### **Vertex Reconstruction**



The life time of B-mesons can be measured from the decay length I, if the momentum of the B-meson ( $\gamma$ -factor) is measured as well.

# Vertexing at the LHC

```
pp → ttH (m=120 GeV)
H → bb
tt → W(IvI)b W(qq)b
```



~ 1200 tracks/BX

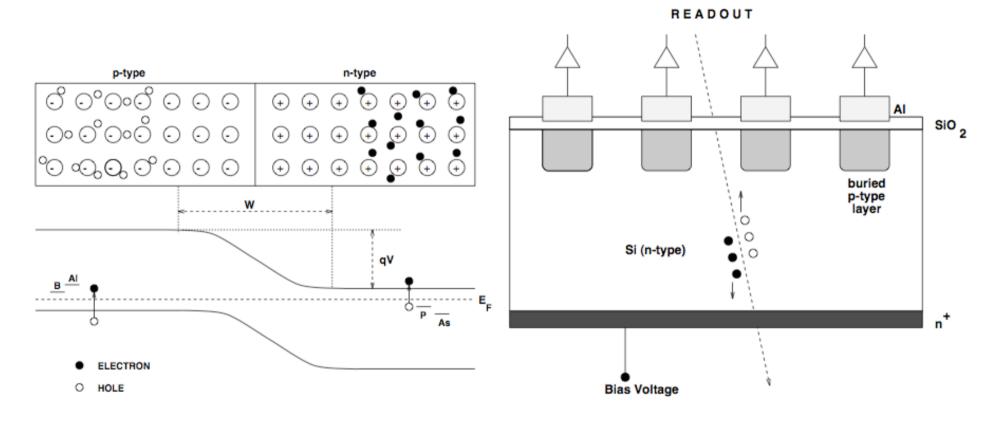
high track density in particular in jets

3D hit information mandatory



pixels

### Solid State Tracking Detector - Silicon



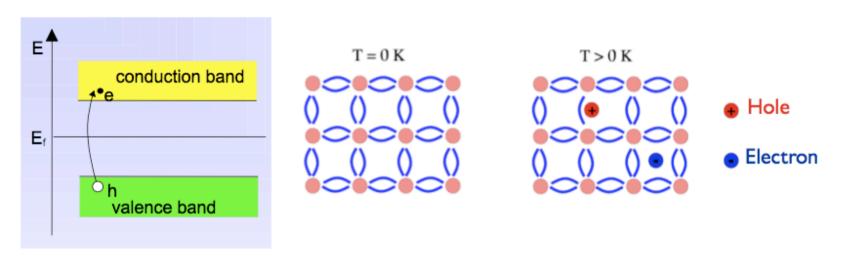
p-n junction (diode).

Silicon:

 $dE/dx \approx 3.8 \,\mathrm{MeV/cm}$ , Band Gap 1.1 eV 3.6 eV to produce one electron-hole pair

Typical thickness:  $300 \,\mu\text{m}$ Strip Distance:  $\geq 10 \,\mu\text{m}$ 

### Doped Semiconductor Detectors



Silicon and germanium have 4 valence electrons, thus four covalent bounds. Thermal excitation excites electrons to the conduction band, which creates holes in the valence band.

Intrinsic electron(hole) concentration:  $n_i = A T^{3/2} \exp(-E_g/2kT)$ 

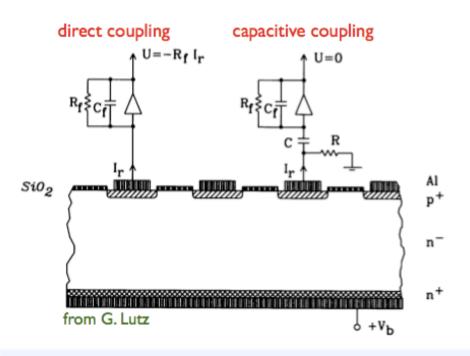
(Si: Energy gap  $E_g = 1.12$  eV, Ge:  $E_g = 0.66$  eV, T = 20 °C  $\Rightarrow$  kT = 1/40 eV)

Typical values at T = 300 K (compare to silicon concentration of  $5 \times 10^{22}$  cm<sup>-3</sup>)

Si: 
$$n_i = 1.5 \times 10^{10} \text{ cm}^{-3}$$

Ge:  $n_i = 2.5 \times 10^{13} \text{ cm}^{-3}$ 

### Silicon Strip Detector



Direct coupling: reverse current I<sub>r</sub> is absorbed by electronics.

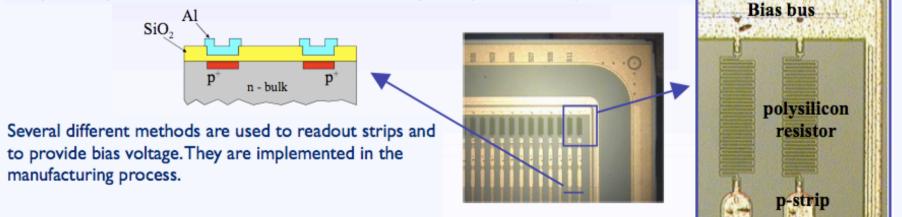
Capacitive coupling: AC part goes to amplifier, DC part goes through bias resistor R.

Typical detector thickness: 300 μm (150μm - 500 μm)

Typical strip separation, pitch p: 20 μm - 150 μm

Position resolution:  $\sigma = p / \sqrt{12} \approx 14 \mu m (p=50 \mu m)$ 

- Bias resistor produced by deposition of polysilicon.
- Capacitors produced via metal readout lines over implants (S<sub>i</sub>O<sub>2</sub> isolation).



### Measured Signal

- Collected Charge for a Minimum Ionizing Particle (MIP)
- Mean energy loss

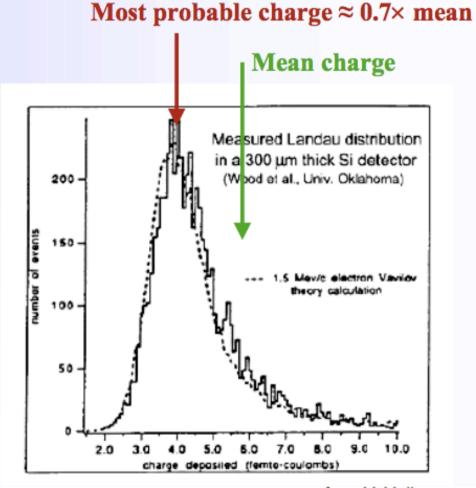
dE/dx (Si) = 3.88 MeV/cm ⇒ 116 keV for 300μm thickness

Most probable energy loss

≈ 0.7 ×mean ⇒ 81 keV

- 3.6 eV to create an e-h pair
  - $\Rightarrow$  72 e-h /  $\mu$ m (mean)
  - $\Rightarrow$  108 e-h /  $\mu$ m (most probable)
- Most probable charge (300 μm)

≈ 22500 e ≈ 3.6 fC



### Charge Collection and Diffusion

#### Charge collection time:

Drift velocity of charge carriers  $v = \mu E$  and drift time  $t_d = d/v = d/\mu E$ . Typical values: d=300  $\mu m$ , E=2.5 kV/cm ( $\mu_e$ =1350 cm<sup>2</sup>/Vs and  $\mu_h$ =450 cm<sup>2</sup>/Vs).

Drift times:  $t_d(e) = 9 \text{ ns}$ ,  $t_d(h) = 27 \text{ ns}$ 

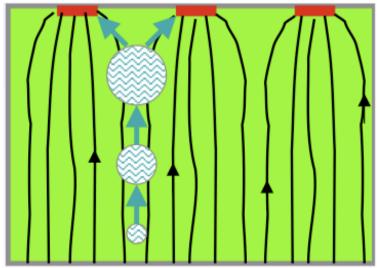
#### Diffusion:

Diffusion of charge cloud caused by scattering of charge carriers. Width of distribution increases with drift time  $t_d$ . Using the diffusion constant  $D=\mu kT/e$  one finds:

$$\sigma = \sqrt{2Dt_d} = \sqrt{rac{2dkT}{eE}}$$

Note that diffusion is the same for electrons and holes, since the mobility drops out.

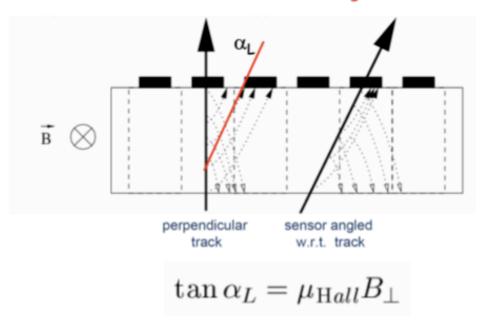
Typical charge width: 8-10 µm in 300 µm thick silicon. Width of charge cloud could be exploited to obtain better position resolution due to charge sharing between strips (charge centroid finding).

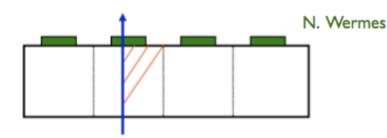


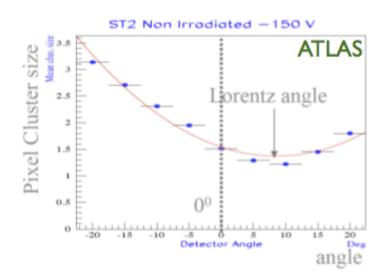
from M. Moll

# Lorentz Angle in B-field









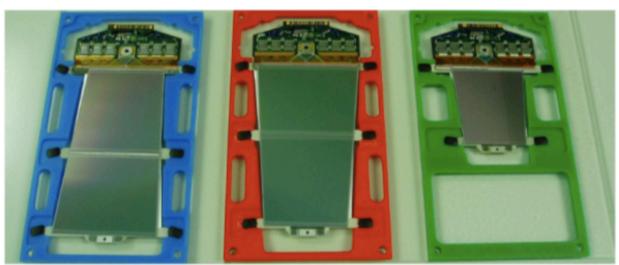
#### Measurement of Lorentz angle:

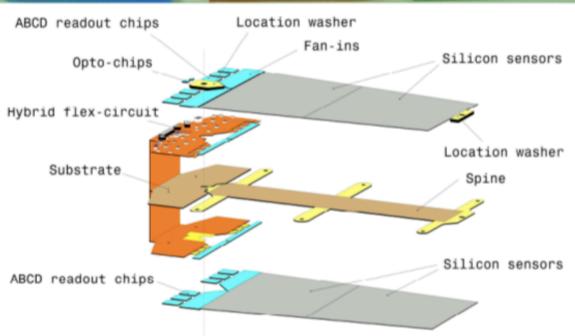
Number of strip (or pixel) hits is minimum, if incident angle of beam is equal to Lorentz angle.

Silicon detectors are built at a tilt angle to compensate for the Lorentz angle.

Effective incident angle = tilt angle + Lorentz angle

### Detector Modules: ATLAS





#### ATLAS Silicon central tracker SCT

#### Endcap:

1976 modules with 2 sensors glued back to back on spine.

Rotation by 20 mrad (Rφ resolution)

Spine conducts heat.

Alignment position of sensors  $\approx 2 \mu m$ .

Strip pitch 80 µm, width 12 µm.

Resolution 16 μm in R-φ.

Operation temperature -7 °C.

99.8% of strips are working.

### Other Silicon Detectors

- Double Sided Strip Detectors
  - Has strip structure also on back side, under 90°
  - Still no real 3d information
  - used to minimize material (multiple scattering)
  - more difficult to operate (noise)

#### Silicon Drift

- Same idea as (wire) drift chamber: Use time information
- drift over several cm achieved (example: ALICE prototype)

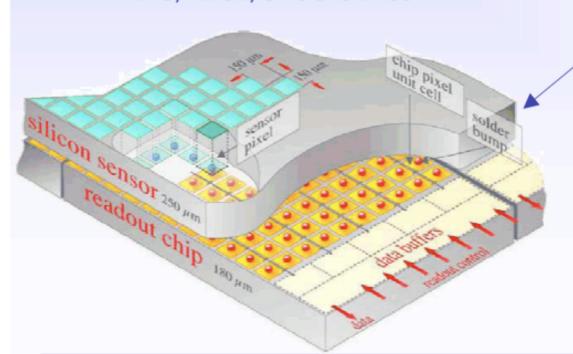
#### Silicon Pixel Detectors

- No strips, but (usually rectangular) pixels
- bonding for electronics very complicated, but doable (example: BTeV prototype)
- give real 3d information
- Usable for trigger

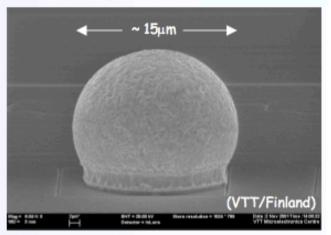
# Hybrid Pixels

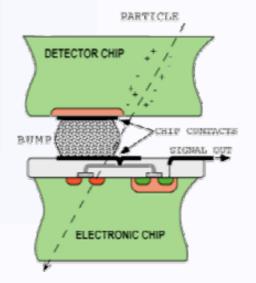
#### HAPS – Hybrid Active Pixel Sensors

- segment silicon to diode matrix with high granularity
   (⇒ true 2D, no reconstruction ambiguity)
- readout electronic with same geometry (every cell connected to its own processing electronics)
- connection by "bump bonding"
- requires sophisticated readout architecture
- Hybrid pixel detectors will be used in LHC experiments:
   ATLAS, ALICE, CMS and LHCb



#### Solder Bump: Pb-Sn



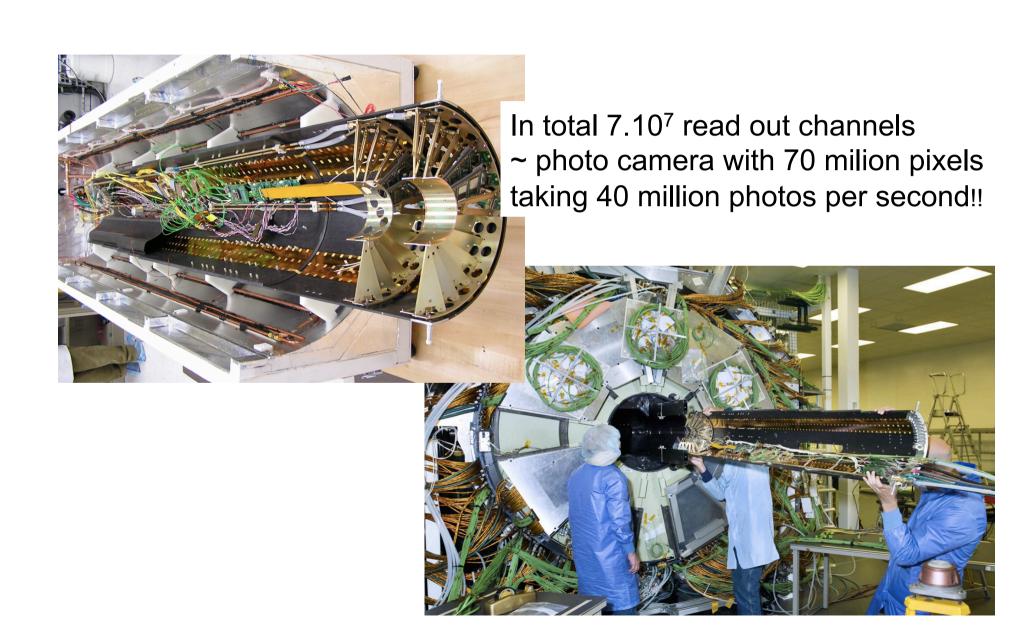


Flip-chip technique



New Vertex Detector for CDF (or D0?). 1 Million strips

### **Pixel Tracking Detector**

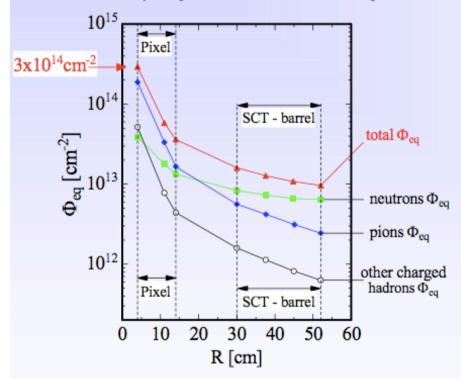


# **END**

# Radiation Damage

#### **■ Example: ATLAS**

Fluences per year at full Luminosity



- Pixel detector: up to  $\Phi_{eq} \approx 3.5 \cdot 10^{14} \, cm^{-2}$  /year
- Dominating type of particle is different for pixel (pions) and strip detectors (neutrons)

#### LHC silicon detectors:

- All detectors have been extensively tested and developed for radiation tolerance and are expected to survive the LHC radiation environment.
- Some experiments have already foreseen upgrades (e.g. LHCb Velo after 3 years).

#### Super LHC

- upgrade of LHC to 10 x higher Luminosity
  - ⇒ 10 x higher radiation levels
  - ⇒ Radiation damage will become a critical issue!
  - ⇒ New, radiation tolerant detectors needed!
    - What is radiation damage?
    - How to cope with it?

from M. Moll

### Radiation Damage

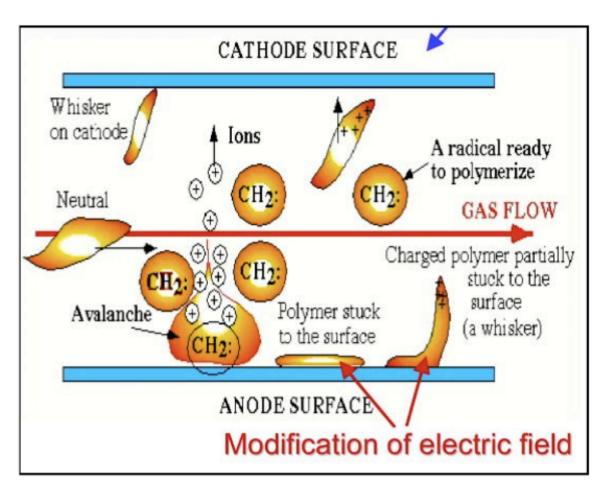
from M. Moll Damage to the silicon crystal: Displacement of lattice atoms E<sub>K</sub>>25 eV Vacancy "point defects", mobile in silicon, particle  $\longrightarrow$   $Si_S$ can react with impurities (O,C,..) Interstitial  $E_{\kappa} > 5 \text{ keV}$ point defects and clusters of defects Distribution of vacancies LUSTER (detailliert) Z=14, A=28 created by a 50 keV Si-ion E=50 keV 505 Vacancies in silicon (typical recoil energy for 1 MeV neutrons): 80 nm 300 **Schematic** [Van Lint 1980] Simulation CLUSTER [M.Huhtinen 2001]

Defects can be electrically active (levels in the band gap)

Abstand von der ursprünglichen Richtung [ Å]

- capture and release electrons and holes from conduction and valence band
- ⇒ can be charged can be generation/recombination centers can be trapping centers

### Detector Aging



Complex plasma-chemical reactions in the avalanche can lead to polymerization.

Deposits on anode and cathode.

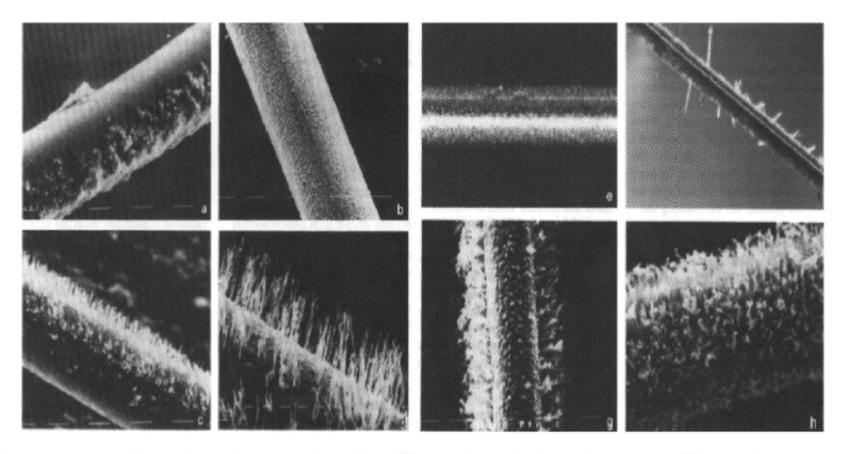
Deposits reduce electric field, which leads to reduced signal amplification (efficiency loss).

#### Malter effect:

Positive ions form a layer on cathode, high E-fields cause continuous electron extraction from cathode.

Leads to continuous discharge current.

### Limitations of Gas Detectors



Wiskers are produced on the anode wire. They absorb the electrons. Thus electrons do not reach the main amplification region very close to the wire. This leads to efficiency loss.